

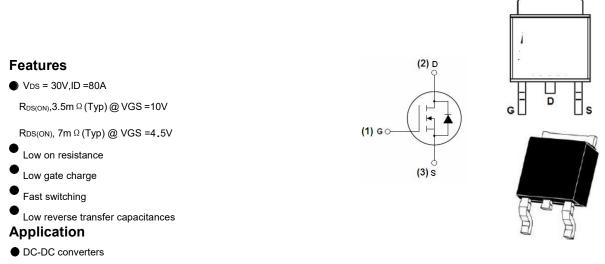
# Product data sheet

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MS80N03 Semiconductor

# Schematic diagram



• Synchronous Rectifier



#### Absolute Maximum Ratings(TA=25℃ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V <sub>DS</sub>	30	V
Gate-Source Voltage		V <sub>GS</sub>	±20	V
TC=25°C			80	Α
Drain Current-Continuous <sup>Note3</sup>	TC=100℃	– I <sub>D</sub>	63	Α
Drain Current-Pulsed <sup>Note1</sup>	I <sub>DM</sub>	200	Α	
Avalanche Energy <sup>Note4</sup>		E <sub>AS</sub>	280	mJ
Avalanche Current		I <sub>AS</sub>	33	Α
Maximum Power Dissipation TC=25°C		PD	105	W
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C	
Operating Junction Temperature Range		TJ	-55 to +150	°C

#### **Thermal Resistance**

Parameter	Symbol	Min.	Тур.	Max	Unit
Thermal Resistance,Junction-to-Case	Rejc	-	3.3	-	°C/W



#### Electrical Characteristics(TJ=25°C unless otherwise noted)

OFF CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V,I <sub>DS</sub> =250uA	30	-	-	V
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	uA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA

ON CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Gate Threshold Voltage	VGS(TH)	$V_{DS}=V_{GS}$ , $I_{DS}=250$ uA	1.0	1.7	2.5	V
Drain-Source On-State Resistance	RDS(ON)	$V_{GS}$ =10V, $I_{DS}$ =30A	-	3.5	5.5	m <b>Ω</b>
		V <sub>GS</sub> =4.5V,I <sub>DS</sub> =20A	-	7	8.9	

DYNAMIC CHARACTERISTICS						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Capacitance	Ciss		-	1963	-	
Output Capacitance	Coss	VDS =15V, VGS = 0V, f=1MHz	-	248	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	I=IMH2	-	221	-	
Gate Resisitance	Da	VDD=0V,VGS=1V,		1.43		Ω
	Rg	F=1MHz	-	1.43	-	52

SWITCHING CHARACTERISTICS							
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Turn-On Delay Time	T <sub>d(on)</sub>		-	55	-		
Rise Time	tr	$V_{GS}$ =10V, $V_{DS}$ =15V,	-	36.4	-		
Turn-Off Delay Time	T <sub>d(off)</sub>	$R_{GEN}=3\Omega I_D=20A$	-	37.5	-	ns	
Fall Time	t <sub>f</sub>		-	14	-		
Total Gate Charge at 10V	Qg		-	41	-		
Gate to Source Gate Charge	Q <sub>gs</sub>	V <sub>DS</sub> =15V,I <sub>DS</sub> =45A, V <sub>GS</sub> =10V	-	6.4	-	nC	
Gate to Drain"Miller"Charge	Q <sub>gd</sub>	VGS=10V	-	11	-	1	

DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>DS</sub> =20A	-	-	1.2	V	
Reverse Recovery Time	trr	TJ=25℃,IF=20A	-	21.7	-	nS	
Reverse Recovery Charge	Qrr	di/dt=100A/us	-	7.2	-	nC	

#### Notes:

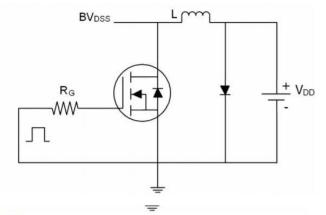
- 1: Repetitive rating, pulse width limited by maximum junction temperature.
- 2: Surface mounted on FR4 Board, t≤10sec.
- 3: Pulse width  $\leq$  300µs, duty cycle  $\leq$  2%.
- 4: EAS condition: L=0.5mH,VDD=15V,VG=10V,V<sub>GATE</sub>=30V,Start TJ=25 $^\circ\!\mathrm{C}.$



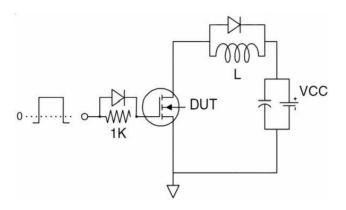


### **Test Circuit**

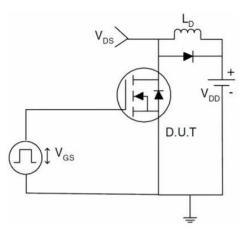
1) EAS Test Circuit



#### 2) Gate Charge Test Circuit

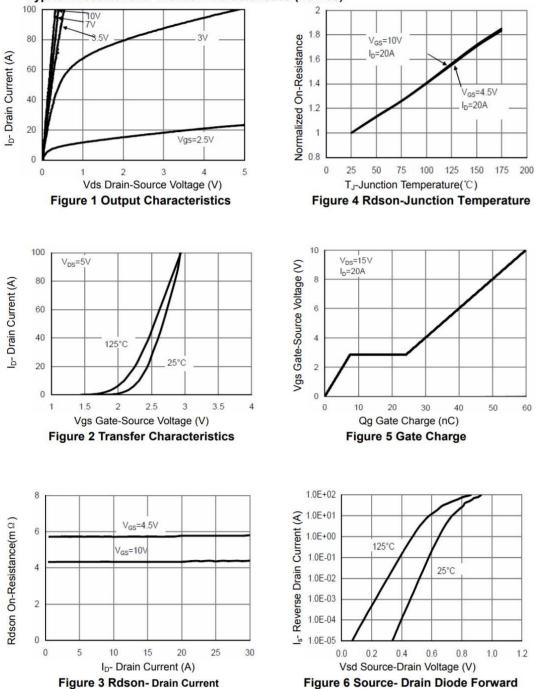


#### 3) Switch Time Test Circuit





#### Typical Electrical and Thermal Characteristics (Curves)





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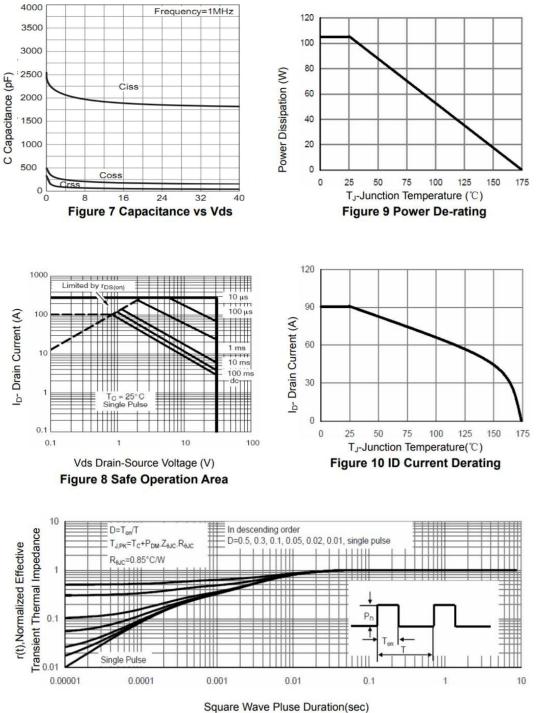
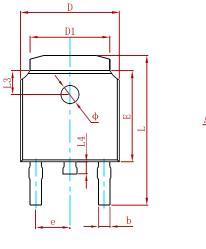


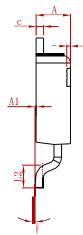
Figure 11 Normalized Maximum Transient Thermal Impedance



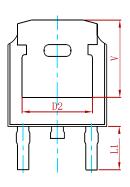


## PACKAGE MECHANICAL DATA



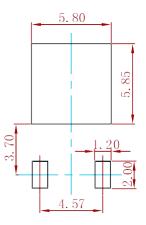


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0. milest	Dimensions	In Millimeters	Dimension	s In Inches
Symbol	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
C	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830	REF.	0.190	REF.
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900	REF.	0.114	REF.
L2	1.400	1.700	0.055	0.067
L3	1.600	REF.	0.063	REF.
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250	REF.	0.207	REF.

# Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm

3. The pad layout is for reference purposes only.

#### **REEL SPECIFICATION**

P/N	PKG	QTY
MS80N03	TO-252	2500



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